

# Electromagnetic compatibility engineering education: problems, challenges and perspectives

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## Abstract

*Education and training problems and challenges in EMC Engineering are discussed. The necessity of physics-based modeling (theory) and hands-on training (practice) are emphasized. An introductory level EMC lecture and a short course outline are given for modern EMC education.*

**Key Words:** *Electromagnetic Compatibility, EMC, EMC education, Electromagnetic Engineering.*

## 1. Introduction

Electromagnetic waves play an increasingly important role in electronics and communication systems. Growth continues in wireless systems, home networking areas, wireless local area networks (WLANs) and wireless personal area networks (WPANs). Next generation technologies are taking root in a number of countries. All these come about via high technology electronic system design. This in turn requires Electromagnetic Compatibility (EMC) engineers with strong theory and practice.

EMC engineering is a multidisciplinary activity and involves physics, electronics, mechanics, chemistry and medicine. It has design, tests, production, quality, marketing, and legal implications. A conventional electromagnetic engineer is concerned with a range of product specific issues, whereas EMC engineers are concerned with all possible external electromagnetic influences on the environment. Issues related to EMC-BEM engineering has been addressed on various platforms by experts for the last couple of years [1-14].

This paper discusses EMC Engineering education. First, problems and challenges related to EMC engineering are reviewed. Then, a summary for an undergraduate (introductory) level EMC engineering lecture and/or a few day condensed EMC course outline is given. Finally, the conclusions are outlined.

## 2. Nature of problems in EMC engineering

Understanding EMC is important to manufacture less interfering, less susceptible and more compatible products [1–8]. The key issue here is the physics of the problem therefore, physics-based modeling and observable-based parameterization are essential.

EMC activities include tests and measurements to determine the level of *emissions* from a product, and the product's *immunity* to outside electrical environment, either by conduction or electromagnetic radiation. The frequency range has no specific limits but is generally concerned with that part of the electromagnetic spectrum used for supply, industrial processes, communications, navigation and radar. Immunity to disturbances and variations in the electrical mains supply, such as: spikes, surges, dips and harmonics are normally considered as EMC tests. The procedure for all EMC tests and measurements are specified by standards; basic, generic, product family or product specific.

Emission tests are quite straightforward. Although requirements like “the worst emission direction is determined first”, or “main and auxiliary devices are connected in a way to yield highest emission”, etc., make it difficult, emission tests and measurements are still easier than immunity tests. While measured emission values are recorded and compared with the threshold values specified in the related standards, quite different performance criteria are used for immunity tests, where device under test is monitored in a high level electromagnetic energy environment.

## 3. Problems and challenges in EMC engineering

The best way to understand and discuss EMC problems and challenges is to follow technical chapters in prestigious EMC related conferences and symposiums. Table 1 lists the most recent EMC Zurich 2009 Conference topics ([www.emc-zurich.ch](http://www.emc-zurich.ch)). This list can be compared with the previous topics listed in the same EMC conference. As seen from the table, chip and IC level EMC problems, system level integration problems, transportation EMC, high power EMC problems are among a few current challenges.

**Table 1.** Current problems and challenges in EMC engineering.

TC-1	EMC Management
TC-2	EMC and Signal Integrity Measurement Techniques
TC-3	EM Environment
TC-4	Chips and IC-Package Level EMC and Signal Integrity
TC-5	EMC and Signal Integrity at PCB level
TC-6	System-Level EMC
TC-7	High Power Protection and Power System EMC
TC-8	Transportation EMC
TC-9	Lightning and High Power Electromagnetics
TC-10	Computational Electromagnetics
TC-11	Biomedical EMC

An EMC engineer should be well-equipped theoretically and practically in terms of the topics listed in Table 2. First of all field and circuit theory background is essential. These two establish the fundamentals of EMC engineering. Transmission lines, antennas, microstrip circuits are also important. Fourier analysis is another important topic. Mathematical definitions of Fourier series and transforms, numerical implementations

in terms of discrete or fast Fourier transforms (DFT, FFT) are crucial. Deterministic and stochastic modeling approaches, numerical simulation techniques are all used in EMC engineering. Finally, hands-on tests and training occupy important role in EMC engineering.

Topics to be covered also include fundamental concepts such as accuracy (the ability of an instrument to measure true value within stated error specifications), precision (the ability to repeat measurements), resolution (the smallest change in value that an instrument can detect), error, uncertainty, physical problems and modeling, discrete environment, analytical models, numerical models, deterministic and stochastic modeling, simulation, validation, and verification. Basic terms and concepts which are crucial in EMC engineering are listed in Table 3.

**Table 2.** Topics should be covered by EMC engineering curricula.

EM Field and Wave Theories
Circuit Theory and Transmission Lines
Microstrip circuits (printed-boards)
Antenna Theory and Wave Scattering
Frequency and Laplace Transforms (FT, FS, DFT, FFT)
Electronic Elements and Frequency Behaviors
Stochastic Modeling and Noise Analysis
Numerical modeling and Simulations
Measurements and Error/Uncertainty Analysis
Signal processing
System Theory.

**Table 3.** Basic engineering terms and concepts.

The meaning of the numbers
Most/Least Significant decimals
Accuracy
Resolution
Precision
Sensitivity
Error and uncertainty
Error Propagation
Deterministic and stochastic approaches
Statistical Evaluations
Confidence Level of the results
Validation, verification, and accreditation

#### 4. An introductory level EMC lecture and course outline

The first step towards EMC engineering education may be introducing an undergraduate departmental level elective EMC course. A typical 14-week course outline of this introductory level EMC course is listed in Table 4. This content may also be given to engineers who graduated without taking any EMC related lecture as a 3-day condensed industrial EMC course.

EMC engineers should understand the physics of the problem and fundamental theorems (which requires strong knowledge of mathematics) and the principles they are dealing with. *Hands-on practice* and *training* is a must in EMC engineering education. Although, labs and test instruments have been simulated as *virtual reality* environments, which may be as good as the real environment, students still need hands-on training. Basic lectures, such as “*measurement techniques*” should be renewed accordingly. Computer simulations are as good as hands-on training, therefore, modeling and simulation lectures should be included in EMC discipline. Novel education techniques such as *problem-based learning*, *inquiry-based teaching* should be considered. Computer simulations are as necessary as hands-on training; therefore, *modeling and simulation lectures* should be included in EMC programs.

**Table 4.** A 14-week EMC lecture or a 3-day EMC course outline.

<p><b>WEEKS 1-5 / DAY – 1:</b>  <b>EMI, Electromagnetic interference and compatibility</b>                  Electromagnetic spectrum                  Interference and coupling                  Compatibility and susceptibility  <b>EMC - BEM Organizations</b>                  IEC, CENELEC, IEEE                  IRPA, ICNIRP, WHO, European EMC Directive  <b>Standards and limits</b>                  Basic standards                  Product family and Product specific standards  <b>Electromagnetic concepts and definitions</b>                  Electromagnetic fields and waves                  Antennas and propagation                  Basic electric and magnetic sources  <b>Transmission Line Modeling</b>                  Lumped and scattered parameter modeling                  Low and high frequency equivalents of basic circuit elements                  Filter design with RLCG, Cross-talk</p>
<p><b>WEEKS 6-10 / DAY – 2:</b>  <b>Non-Linearity and inter-modulation effects</b>                  Harmonics and their effects                  Inter-modulation effects                  Flicker effects  <b>Stochastic processes and noise analysis</b>                  Signals and their behaviors                  Noise spectrum, SNR, SIR  <b>Frequency analysis</b>                  Fourier transformation and series                  Discrete Fourier transform                  FFT, DFT  <b>EMC and numerical modeling</b>                  FDTD : Finite Difference Time-Domain                  TLM : Transmission Line Matrix                  MoM : Method of Moments                  SSPE : Split-Step Parabolic Equation                  FE : Finite - Element</p>

Table 4. Continued.

<p><b>WEEKS 11-14 / DAY – 3:</b></p> <p><b>Tests and measurement environments</b>  Open field test sites and Normalized Site Attenuation (NSA)  Screened room measurements  Anechoic test rooms</p> <p><b>EMC Tests and measurements</b>  Electromagnetic interference measurements  Conducted and radiated interference measurements  Electromagnetic compatibility and susceptibility measurements  Compatibility against conducted interference  Compatibility against radiated interference  Electrostatic Discharge tests, EMP, EFT</p> <p><b>EMC Tests and Evaluation</b>  Error/Uncertainty analysis  Evaluation and interpretation</p> <p><b>EMC Design and protection techniques</b>  Screening, Grounding, shielding, filtering  PCB design and microstrips  Cables and connectors</p> <p><b>BEM and public concern</b></p>
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## 5. Conclusions and discussions

EMC problems mostly do not obey regular rules and laws governed by well known electromagnetic wave and circuit theories, and can be solely solved by experience, very often by trial and error. EMC deals with EM interference problems where major design tools are grounding, shielding and filtering and concerns with tests and measurements in the near fields. The interdisciplinary character of EMC engineering requires novel approaches and techniques.

EMC problems usually do not agree with our expectations. The most dangerous case may be the case when the results of the measurement or simulation agree with what we expect. Therefore, an EMC-BEM engineer should never be sure of the results until all critical checks are finished. EMC engineers become more publicized parallel to exponential growth in wireless communication. They may attend to public meetings, regional activities to answer questions related to mobile phones, base stations and safety. Therefore, lectures like “*Science Technology and Society*,” or “*Public Understanding of Science*” should be included in this education.

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